RAD-TOLERANT CLASS-V REGULATING PULSE WIDTH MODULATOR

FEATURES

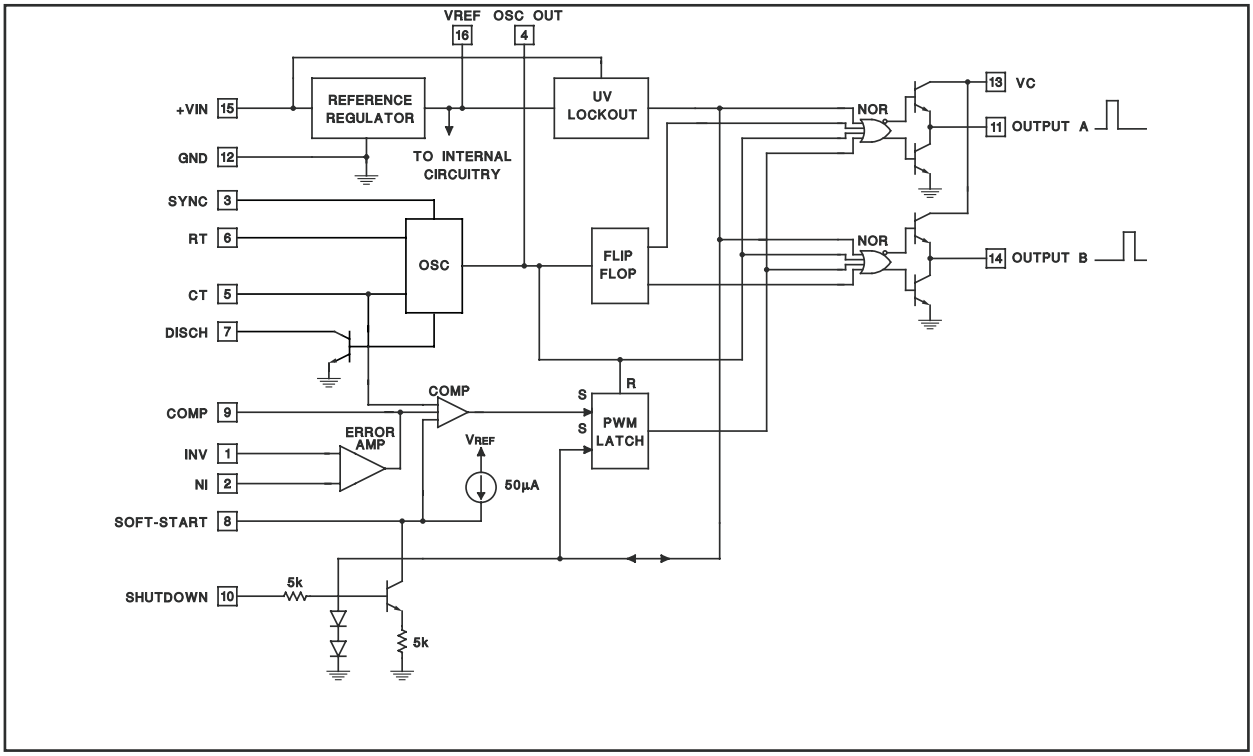
- **QML-V Qualified, SMD 5962-89511**
- **Rad-Tolerant: 30 kRad (Si) TID** (1)
- **8-V to 35-V Operation**
- **5.1-V Buried Zener Reference Trimmed to ±0.75%**
- **100-Hz to 400-kHz Oscillator Range**
- **Separate Oscillator Sync Terminal**
- **Adjustable Deadtime Control**
- **Internal Soft Start**
- **Pulse-by-Pulse Shutdown**
- **Input Undervoltage Lockout With Hysteresis**
- **Latching PWM to Prevent Multiple Pulses**
- **Dual Source/Sink Output Drivers**
- **Low Cross Conduction Output Stage**
- **Tighter Reference Specifications**

(1) Radiation tolerance is a typical value based upon initial device qualification with dose rate = 10 mrad/sec. Radiation Lot Acceptance Testing is available - contact factory for details.

DESCRIPTION

The UC1525B pulse width modulator integrated circuit is designed to offer improved performance and lowered external parts count when used in designing all types of switching power supplies. The on-chip 5.1-V buried zener reference is trimmed to ±0.75%, and the input common-mode range of the error amplifier includes the reference voltage, eliminating external resistors. A sync input to the oscillator allows multiple units to be slaved or a single unit to be synchronized to an external system clock. A single resistor between the CT and the discharge terminals provide a wide range of dead-time adjustment. These devices also feature built-in soft-start circuitry with only an external timing capacitor required. A shutdown terminal controls both the soft-start circuitry and the output stages, providing instantaneous turn off through the PWM latch with pulsed shutdown, as well as soft-start recycle with longer shutdown commands. These functions are also controlled by an undervoltage lockout which keeps the outputs off and the soft-start capacitor discharged for sub-normal input voltages. This lockout circuitry includes approximately 500 mV of hysteresis for jitter-free operation. Another feature of these PWM circuits is a latch following the comparator. Once a PWM pulse has been terminated for any reason, the outputs remain off for the duration of the period. The latch is reset with each clock pulse. The output stages are totem-pole designs capable of sourcing or sinking in excess of 200 mA. The UC1525B output stage features NOR logic, giving a LOW output for an OFF state.

BLOCK DIAGRAM



This device has limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION(1)

T_A	PACKAGE(2)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	FK	5962-8951106V2A	UC1525BFK-SP

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

ABSOLUTE MAXIMUM RATINGS(1)(2)

over operating free-air temperature range (unless otherwise noted)

$+V_{IN}$	Supply voltage		40 V
V_C	Collector supply voltage		40 V
	Logic inputs		–0.3 V to 5.5 V
V_I	Analog inputs		–0.3 V to V_{IN}
I_O	Output current, source or sink		500 mA
	Reference output current		50 mA
	Oscillator charging current		5 mA
P_D	Power dissipation	T_A = 25°C	1000 mW
		T_C = 25°C	2000 mW
T_J	Operating junction temperature		–55°C to 150°C
T_{stg}	Storage temperature range		–65°C to 150°C
T_{lead}	Lead temperature (soldering, 10 seconds)		300°C

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltages are with respect to ground. Currents are positive into, negative out of the specified terminal.

RECOMMENDED OPERATING CONDITIONS(1)

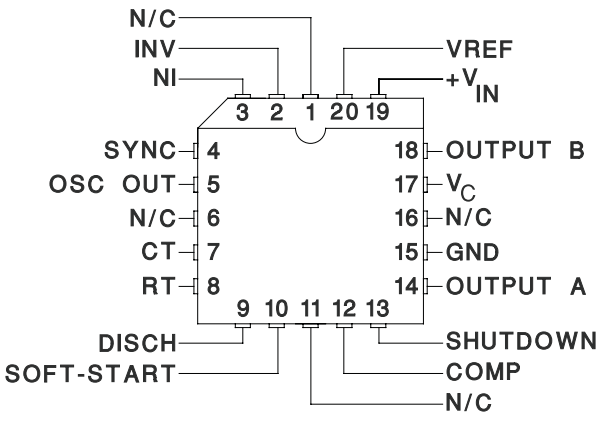
over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
$+V_{IN}$	Input voltage	8	35	V
V_C	Collector supply voltage	4.5	35	V
	Sink/source load current (steady state)	0	100	mA
	Sink/source load current (peak)	0	400	mA
	Reference load current	0	20	mA
	Oscillator frequency range	0.1	400	kHz
	Oscillator timing resistor	2	150	kΩ
	Oscillator timing capacitor	0.001	0.1	µF
	Dead time resistor range	0	500	Ω

(1) Range over which the device is functional and parameter limits are specified.

CONNECTION DIAGRAM

LCC-20, PLCC-20 (Top View)
FK Package



ELECTRICAL CHARACTERISTICS

V_{IN} = 20 V, $T_A = T_J$ = –55°C to 125°C (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Reference Section					
Output voltage	T_J = 25°C	5.062	5.10	5.138	V
Line regulation	V_{IN} = 8 V to 35 V		5	10	mV
Load regulation	I_L = 0 mA to 20 mA		7	15	mV
Temperature stability(1)	Over operating range		10	50	mV
Total output variation	Over line, load, and temperature	5.036		5.164	V
Short-circuit current	V_{REF} = 0 V, T_J = 25°C		80	100	mA
Output noise voltage(1)	10 Hz ≤ f ≤ 10 kHz, T_J = 25°C		40	200	µVrms
Oscillator Section					
Initial accuracy(2)	T_J = 25°C		±2	±6	%
Voltage stability(2)	V_{IN} = 8 V to 35 V		±0.3	±1	%
Temperature stability(1)(2)	Over operating range		±3	±6	%
Minimum frequency	R_T = 200 kΩ, C_T = 0.1 µF			120	Hz
Maximum frequency	R_T = 2 kΩ, C_T = 470 pF	400			kHz
Current mirror	I_{RT} = 2 mA	1.7	2.	2.2	mA
Clock amplitude(2)		3	3.5		V
Clock width(2)	T_J = 25°C	0.3	0.5	1	µs
Sync threshold		1.2	2	2.8	V
Sync input current	Sync = 3.5 V		1	2.5	mA

(1) Parameters ensured by design and/or characterization, if not production tested.
(2) Tested at f_{osc} = 40 kHz (R_T = 3.6 kΩ, C_T = 0.01 µF, R_D = 0 Ω).
Approximate oscillator frequency is defined by: $f = 1/(C_T (0.7 \times R_T + 3R_D))$.

ELECTRICAL CHARACTERISTICS (continued)

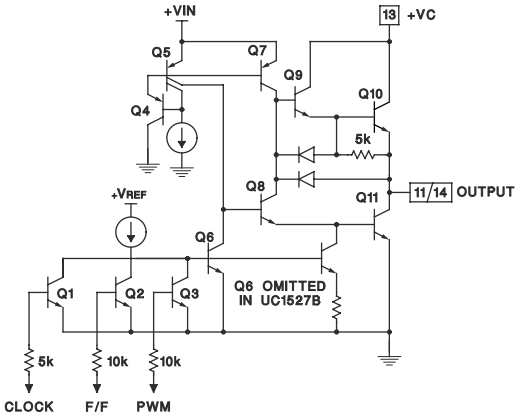
V_{IN} = 20 V, $T_A = T_J$ = –55°C to 125°C (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Error Amplifier Section (V_{CM} = 5.1 V)					
Input offset voltage			0.5	5	mV
Input bias current			1	10	µA
Input offset current				1	µA
DC open loop gain	$R_L \geq 10$ MΩ	60	75		dB
Gain-bandwidth product (3)	A_V = 0 dB, T_J = 25°C	1	2		MHz
Ouput low level			0.2	0.5	V
Output high level		3.8	5.6		V
Common mode rejection	V_{CM} = 1.5 V to 5.2 V	60	75		dB
Supply voltage rejection	V_{IN} = 8 V to 35 V	50	60		dB
PWM Comparator					
Minimum duty cycle				0	%
Maximum duty cycle(4)		45	49		%
Input threshold(4)	Zero duty cycle	0.7	0.9		V
Input threshold(4)	Maximum duty cycle		3.3	3.6	V
Input bias current			0.05		µA
Shutdown Section					
Soft start current	$V_{SHUTDOWN}$ = 0 V, $V_{SOFTSTART}$ = 0 V	25	50	80	µA
Soft start low level	$V_{SHUTDOWN}$ = 2.5 V		0.4	0.7	V
Shutdown threshold	To outputs, $V_{SOFTSTART}$ = 5.1 V, T_J = 25°C	0.6	0.8	1	V
Shutdown input current	$V_{SHUTDOWN}$ = 2.5 V		0.4	1	mA
Shutdown delay(3)	$V_{SHUTDOWN}$ = 2.5 V, T_J = 25°C		0.2	0.5	µs
Output Drivers (Each OUtput) (V_C = 20 V)					
Output low level	I_{SINK} = 20 mA		0.2	0.4	V
	I_{SINK} = 100 mA		1	2	
Output high level	I_{SOURCE} = 20 mA	18	19		V
	I_{SOURCE} = 100 mA	17	18		
Undervoltage lockout	V_{COMP} and $V_{SOFTSTART}$ = High	6	7	8	V
Collector leakage	V_C = 35 V			200	µA
Rise time(3)	C_L = 1 nF, T_J = 25°C		100	600	ns
Fall time(3)	C_L = 1 nF, T_J = 25°C		50	300	ns
Cross conduction charge	Per cycle, T_J = 25°C		30		nc
Total Standby Current					
Supply current	V_{IN} = 35 V		14	20	mA

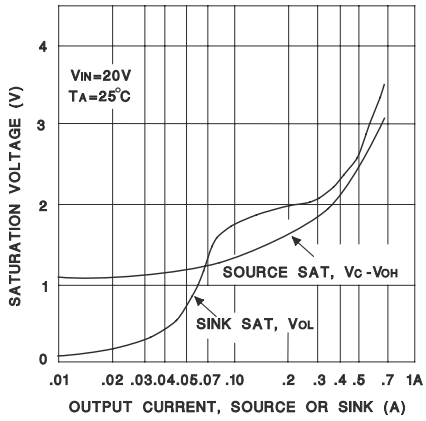
(3) Parameters ensured by design and/or characterization, if not production tested.
(4) Tested at f_{osc} = 40 kHz (R_T = 3.6 kΩ, C_T = 0.01 µF, R_D = 0 Ω).
Approximate oscillator frequency is defined by: $f = 1/(C_T (0.7 \times R_T + 3R_D))$.

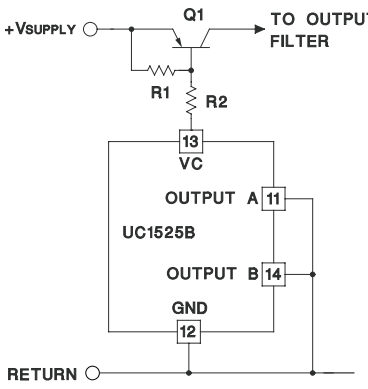
PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTICS

Output Circuit (½ Circuit Shown)

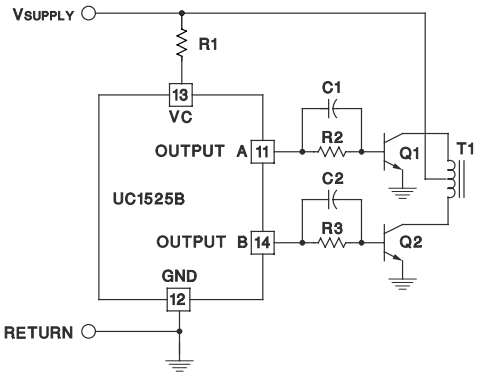


Output Saturation Characteristics

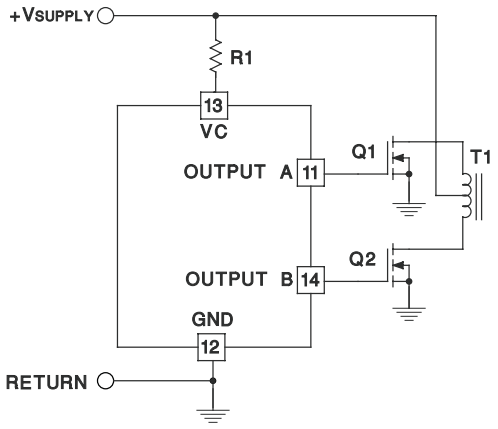




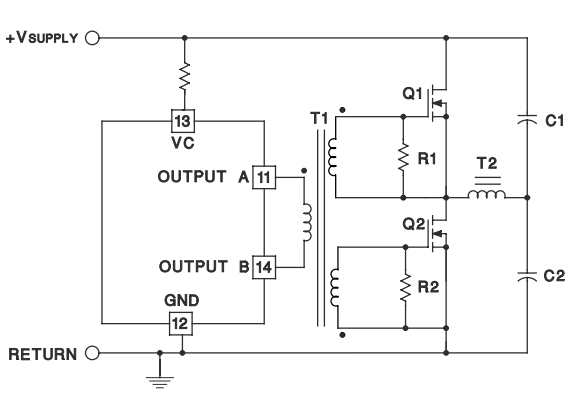
For single ended supplies, the driver outputs are grounded. The VC terminal is switched to ground by the totem-pole source transistors on alternate oscillator cycles.



In conventional push-pull bipolar designs, forward base drive is controlled by R1-R3. Rapid turn-off times for the power devices are acheived with speed-up capacitors C, and C2.



The low source impedance of the output drivers provides rapid charging of power FET input capacitance while minimizing external components.

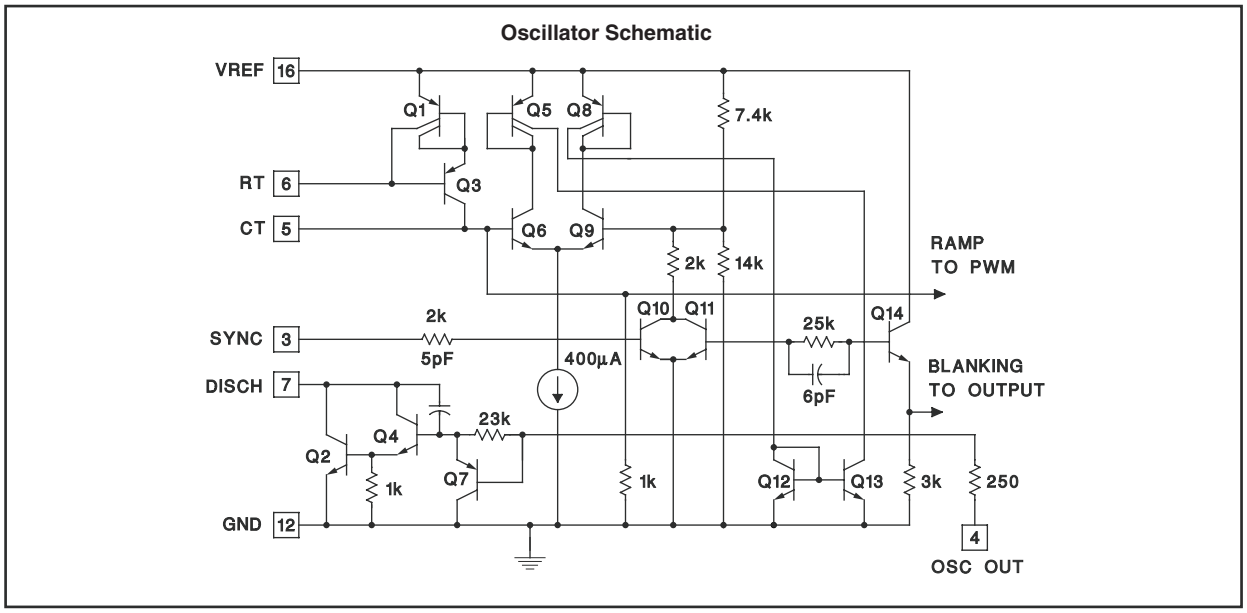


Low power transformers can be driven directly by the UC1525B. Automatic reset occurs during dead time, when both ends of the primary winding are switched to ground.

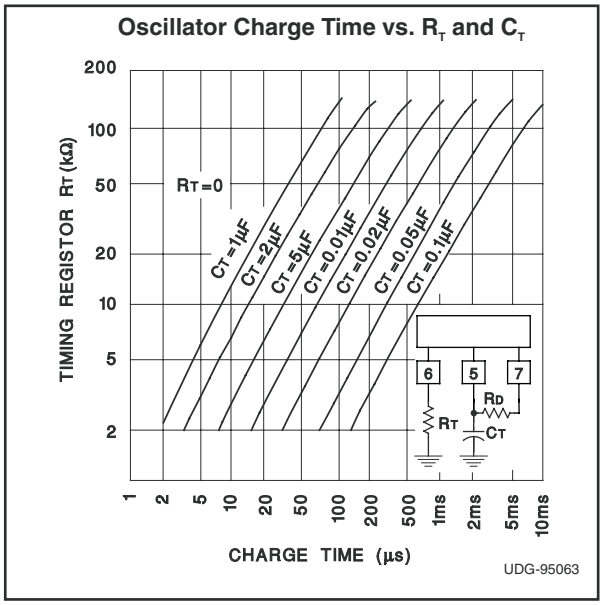
PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTICS (continued)

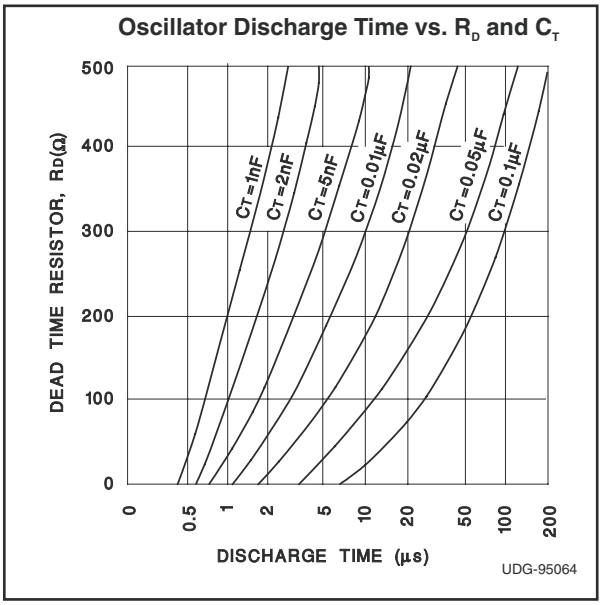
Since both the compensation and soft-start terminals (Pins 9 and 8) have current source pullups, either can readily accept a pulldown signal, which only has to sink a maximum of 100 μA to turn off the outputs. This is subject to the added requirement of discharging whatever external capacitance may be attached to these pins.

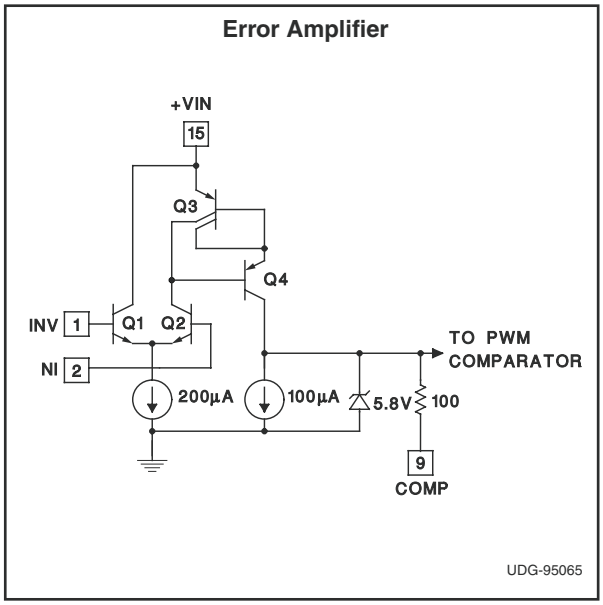
An alternate approach is the use of the shutdown circuitry of Pin 10, which has been improved to enhance the available shutdown options. Activating this circuit by applying a positive signal on Pin 10 performs two functions: the PWM latch is immediately set providing the fastest turn-off signal to the external soft-start capacitor. If the shutdown command is short, the PWM signal is terminated without significant discharge of the soft-start capacitor, thus, allowing, for example, a convenient implementation of pulse-by-pulse current limiting. Holding Pin 10 high for a longer duration, however, ultimately discharges this external capacitor, recycling slow turn-on upon release.

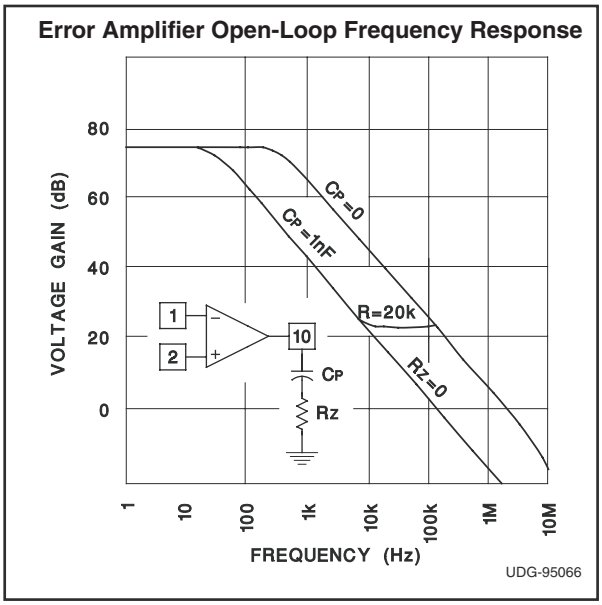


PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTICS (continued)



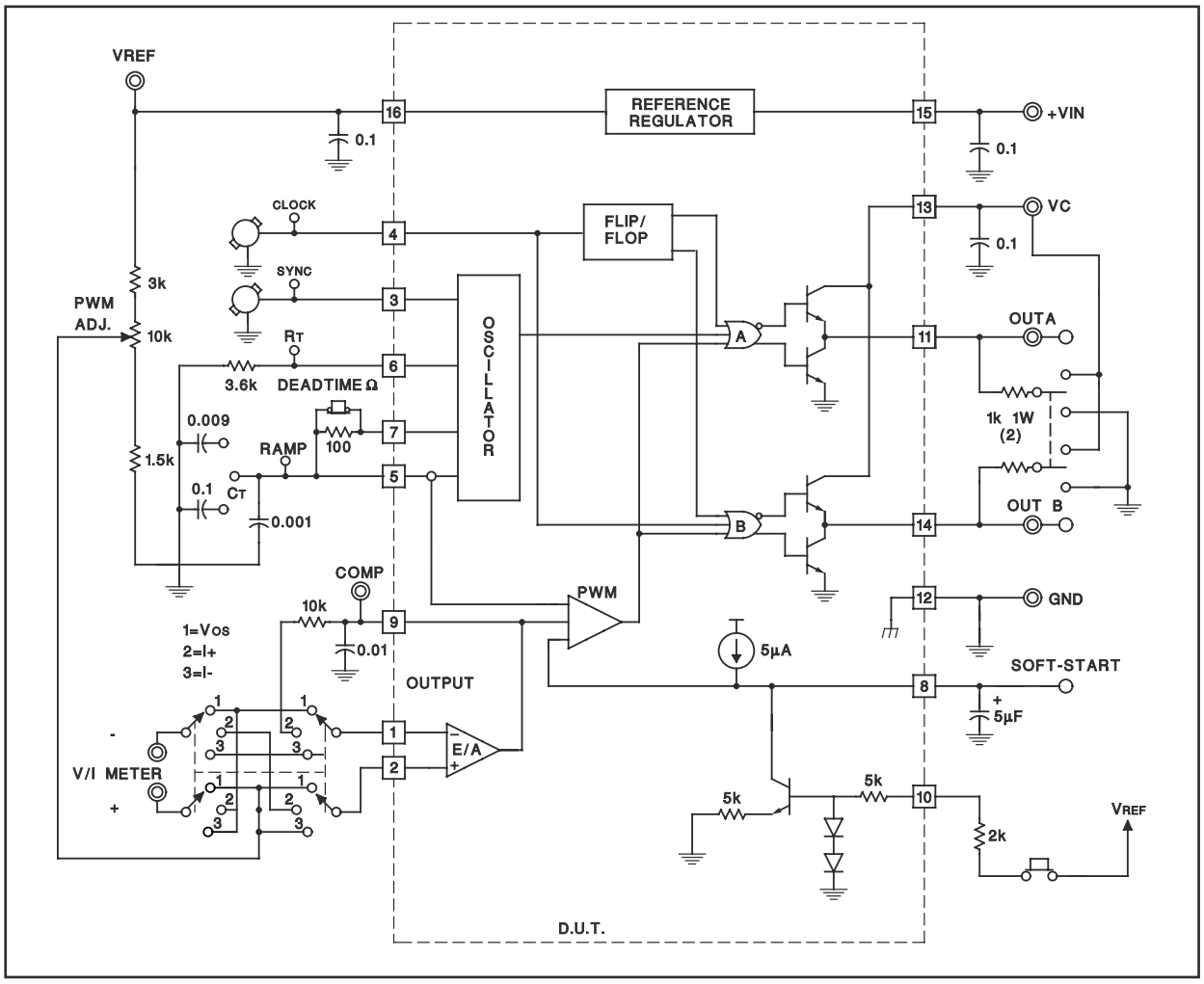






PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTICS (continued)

LAB TEST FIXTURE



PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-8951105V2A	Active	Production	LCCC (FK) | 20	55 | TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8951105V2A UC1525BL QMLV
5962-8951105V2A.A	Active	Production	LCCC (FK) | 20	55 | TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8951105V2A UC1525BL QMLV
5962-8951105VEA	Active	Production	CDIP (J) | 16	25 | TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8951105VEA UC1525BJQMLV
5962-8951105VEA.A	Active	Production	CDIP (J) | 16	25 | TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8951105VEA UC1525BJQMLV
5962-8951106V2A	Active	Production	LCCC (FK) | 20	55 | TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8951106V2A UC1525BFK -SP
5962-8951106V2A.A	Active	Production	LCCC (FK) | 20	55 | TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8951106V2A UC1525BFK -SP

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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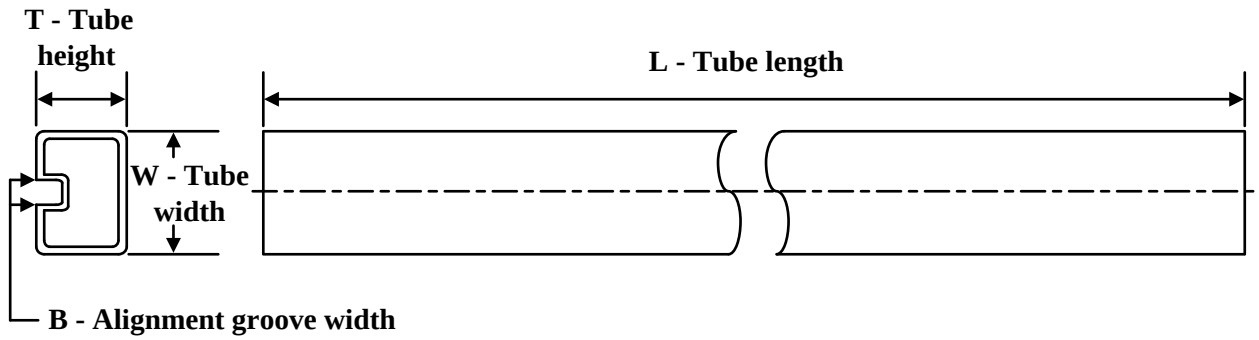
OTHER QUALIFIED VERSIONS OF UC1525B-SP :

- Catalog : UC1525B

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-8951105V2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8951105V2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8951106V2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8951106V2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA

GENERIC PACKAGE VIEW

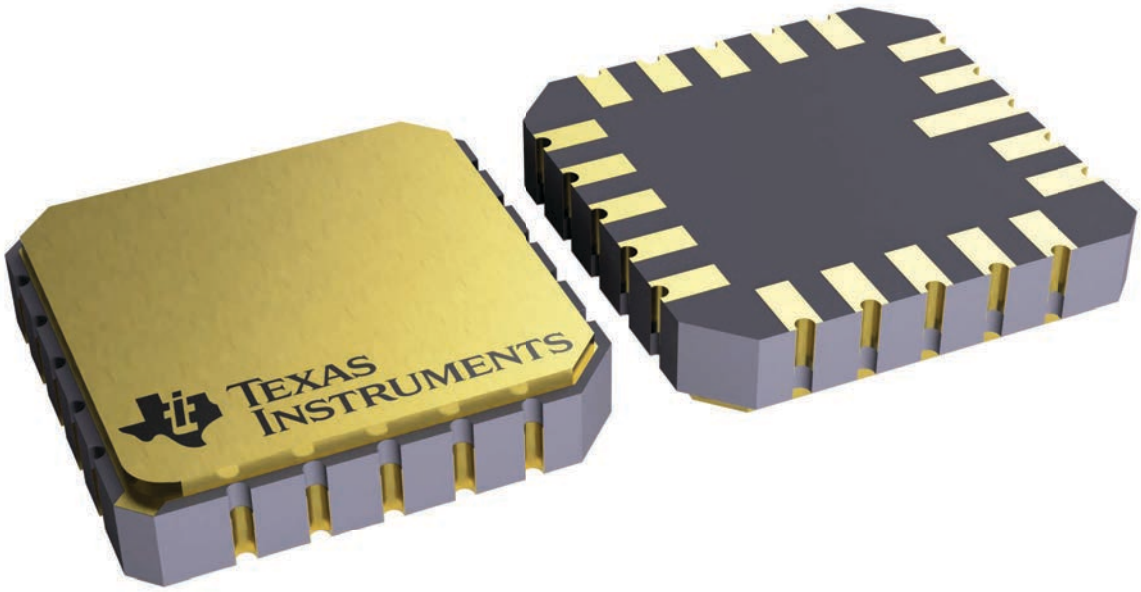
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

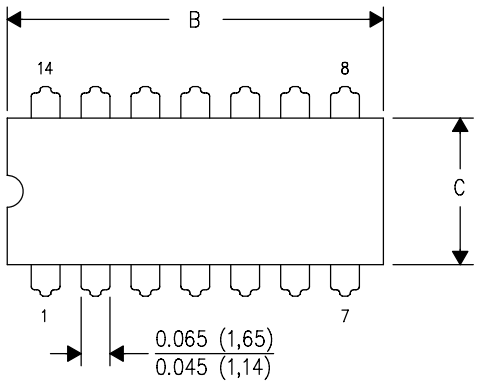


4229370VA\

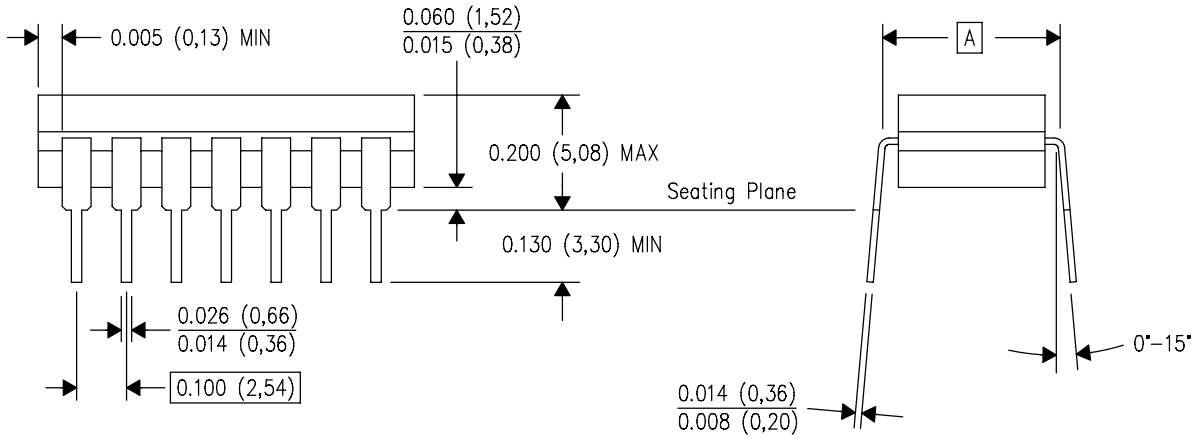
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

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Last updated 10/2025